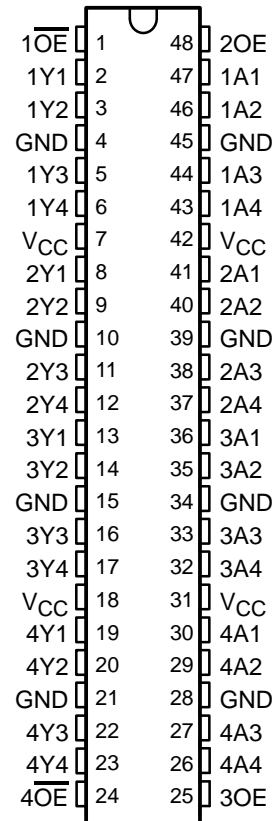


# SN54ABT16241, SN74ABT16241A 16-BIT BUFFERS/DRIVERS WITH 3-STATE OUTPUTS

SCBS096F – FEBRUARY 1991 – REVISED JANUARY 1997

- Members of the Texas Instruments *Widebus™* Family
- State-of-the-Art *EPIC-II B™* BiCMOS Design Significantly Reduces Power Dissipation
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17
- Typical  $V_{OLP}$  (Output Ground Bounce) < 1 V at  $V_{CC} = 5$  V,  $T_A = 25^\circ\text{C}$
- Distributed  $V_{CC}$  and GND Pin Configuration Minimizes High-Speed Switching Noise
- Flow-Through Architecture Optimizes PCB Layout
- High-Drive Outputs (–32-mA  $I_{OH}$ , 64-mA  $I_{OL}$ )
- Package Options Include Plastic 300-mil Shrink Small-Outline (DL), Thin Shrink Small-Outline (DGG), and Thin Very Small-Outline (DGV) Packages and 380-mil Fine-Pitch Ceramic Flat (WD) Package Using 25-mil Center-to-Center Spacings

SN54ABT16241 . . . WD PACKAGE  
SN74ABT16241A . . . DGG, DGV, OR DL PACKAGE  
(TOP VIEW)



## description

The SN54ABT16241 and SN74ABT16241A are 16-bit buffers and line drivers designed specifically to improve both the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters.

These devices can be used as four 4-bit buffers, two 8-bit buffers, or one 16-bit buffer. These devices provide true outputs and complementary output-enable (OE and  $\overline{OE}$ ) inputs.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver. OE should be tied to GND through a pulldown resistor; the minimum value of the resistor is determined by the current-sourcing capability of the driver.

The SN54ABT16241 is characterized for operation over the full military temperature range of  $-55^\circ\text{C}$  to  $125^\circ\text{C}$ . The SN74ABT16241A is characterized for operation from  $-40^\circ\text{C}$  to  $85^\circ\text{C}$ .



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS  
INSTRUMENTS**

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SN54ABT16241, SN74ABT16241A  
 16-BIT BUFFERS/DRIVERS  
 WITH 3-STATE OUTPUTS

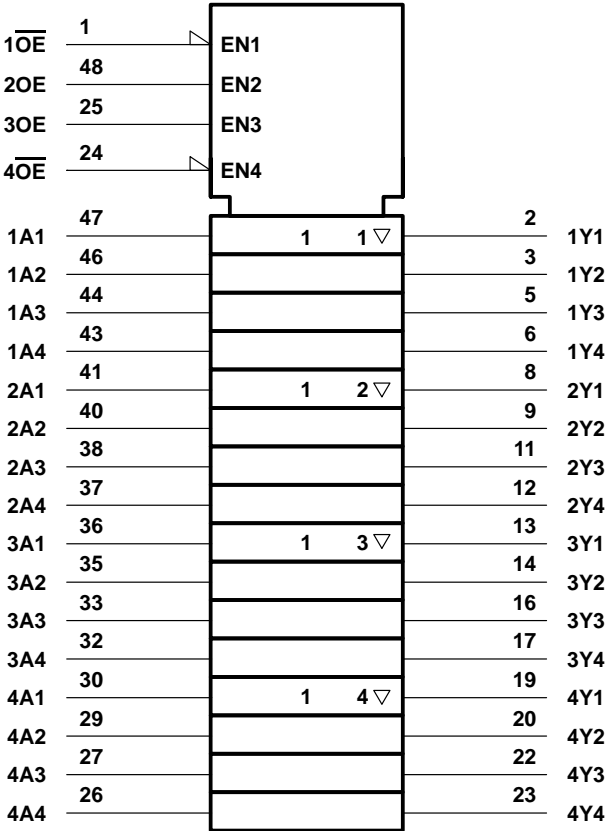
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FUNCTION TABLES

INPUTS		OUTPUTS 1Y, 4Y
1OE, 4OE	1A, 4A	
L	H	H
L	L	L
H	X	Z

INPUTS		OUTPUTS 2Y, 3Y
2OE, 3OE	2A, 3A	
H	H	H
H	L	L
L	X	Z

logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

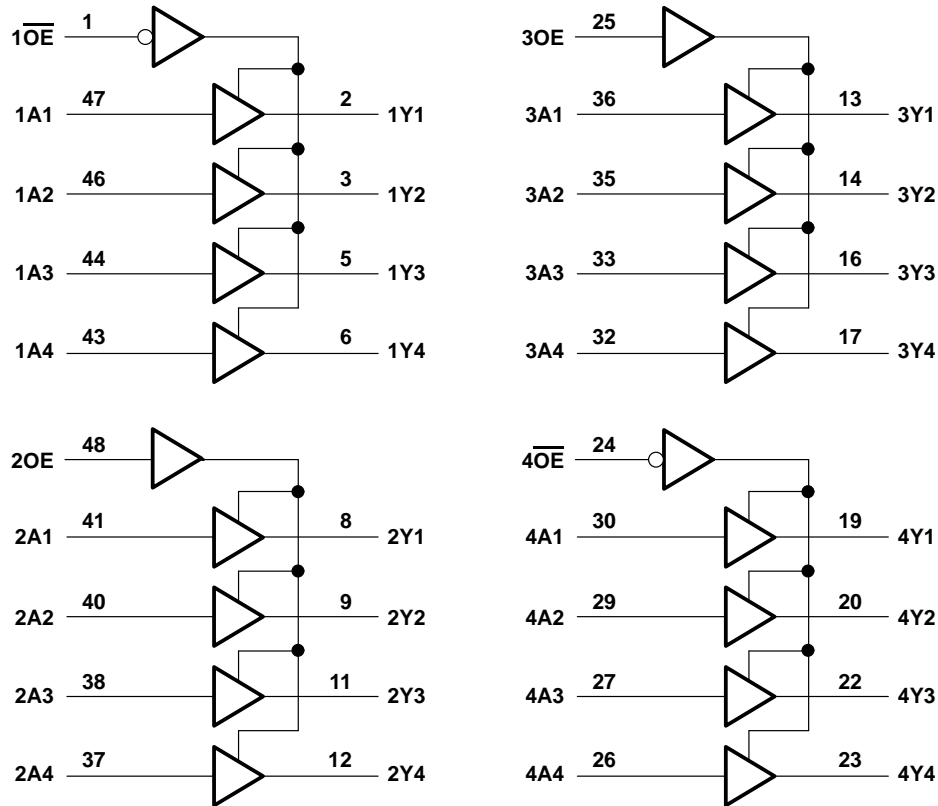
# SN54ABT16241, SN74ABT16241A

## 16-BIT BUFFERS/DRIVERS

### WITH 3-STATE OUTPUTS

SCBS096F – FEBRUARY 1991 – REVISED JANUARY 1997

#### logic diagram (positive logic)



#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

Supply voltage range, $V_{CC}$	–0.5 V to 7 V
Input voltage range, $V_I$ (see Note 1)	–0.5 V to 7 V
Voltage range applied to any output in the high or power-off state, $V_O$	–0.5 V to 5.5 V
Current into any output in the low state, $I_O$ : SN54ABT16241	96 mA
SN74ABT16241A	128 mA
Input clamp current, $I_{IK}$ ( $V_I < 0$ )	–18 mA
Output clamp current, $I_{OK}$ ( $V_O < 0$ )	–50 mA
Package thermal impedance, $\theta_{JA}$ (see Note 2): DGG package	89°C/W
DGV package	93°C/W
DL package	94°C/W
Storage temperature range, $T_{stg}$	–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.  
2. The package thermal impedance is calculated in accordance with EIA/JEDEC Std JESD51.

# SN54ABT16241, SN74ABT16241A

## 16-BIT BUFFERS/DRIVERS

### WITH 3-STATE OUTPUTS

SCBS096F – FEBRUARY 1991 – REVISED JANUARY 1997

#### recommended operating conditions (see Note 3)

			SN54ABT16241		SN74ABT16241A		UNIT
			MIN	MAX	MIN	MAX	
$V_{CC}$	Supply voltage		4.5	5.5	4.5	5.5	V
$V_{IH}$	High-level input voltage		2		2		V
$V_{IL}$	Low-level input voltage			0.8		0.8	V
$V_I$	Input voltage		0	$V_{CC}$	0	$V_{CC}$	V
$I_{OH}$	High-level output current			–24		–32	mA
$I_{OL}$	Low-level output current			48		64	mA
$\Delta t/\Delta v$	Input transition rise or fall rate	Outputs enabled		10		10	ns/V
$T_A$	Operating free-air temperature		–55	125	–40	85	°C

NOTE 3: Unused inputs must be held high or low to prevent them from floating.

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		$T_A = 25^\circ\text{C}$			SN54ABT16241		SN74ABT16241A		UNIT
				MIN	TYP†	MAX	MIN	MAX	MIN	MAX	
$V_{IK}$		$V_{CC} = 4.5\text{ V}$ , $I_I = -18\text{ mA}$				–1.2		–1.2		–1.2	V
$V_{OH}$		$V_{CC} = 4.5\text{ V}$ , $I_{OH} = -3\text{ mA}$		2.5			2.5		2.5		V
		$V_{CC} = 5\text{ V}$ , $I_{OH} = -3\text{ mA}$		3			3		3		
	$V_{CC} = 4.5\text{ V}$	$I_{OH} = -24\text{ mA}$		2			2				
		$I_{OH} = -32\text{ mA}$		2*					2		
$V_{OL}$	$V_{CC} = 4.5\text{ V}$	$I_{OL} = 48\text{ mA}$				0.55		0.55			V
		$I_{OL} = 64\text{ mA}$				0.55*				0.55	
$V_{hys}$					100						mV
$I_I$		$V_{CC} = 5.5\text{ V}$ , $V_I = V_{CC}$ or GND				$\pm 1$		$\pm 1$		$\pm 1$	$\mu\text{A}$
$I_{OZH}$		$V_{CC} = 5.5\text{ V}$ , $V_O = 2.7\text{ V}$				10		10		10	$\mu\text{A}$
$I_{OZL}$		$V_{CC} = 5.5\text{ V}$ , $V_O = 0.5\text{ V}$				–10		–10		–10	$\mu\text{A}$
$I_{off}$		$V_{CC} = 0$ , $V_I$ or $V_O \leq 4.5\text{ V}$				$\pm 100$				$\pm 100$	$\mu\text{A}$
$I_{CEX}$		$V_{CC} = 5.5\text{ V}$ , $V_O = 5.5\text{ V}$	Outputs high			50		50		50	$\mu\text{A}$
$I_{O\ddagger}$		$V_{CC} = 5.5\text{ V}$ , $V_O = 2.5\text{ V}$		–50	–100	–180	–50	–180	–50	–180	mA
$I_{CC}$	$V_{CC} = 5.5\text{ V}$ , $I_O = 0$ , $V_I = V_{CC}$ or GND	Outputs high				3*		2		3	mA
		Outputs low				34*		32		34	
		Outputs disabled				3*		2		3	
$\Delta I_{CC}\S$	Data inputs	$V_{CC} = 5.5\text{ V}$ , One input at 3.4 V, Other inputs at $V_{CC}$ or GND	Outputs enabled			1		1.5		1	mA
			Outputs disabled			0.05		1		0.05	
	Control inputs	$V_{CC} = 5.5\text{ V}$ , One input at 3.4 V, Other inputs at $V_{CC}$ or GND				1.5		1.5		1.5	
$C_i$		$V_I = 2.5\text{ V}$ or $0.5\text{ V}$				3.5					pF
$C_o$		$V_O = 2.5\text{ V}$ or $0.5\text{ V}$				7.5					pF

\* On products compliant to MIL-PRF-38535, this parameter does not apply.

† All typical values are at  $V_{CC} = 5\text{ V}$ .

‡ Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

§ This is the increase in supply current for each input that is at the specified TTL voltage level rather than  $V_{CC}$  or GND.



**SN54ABT16241, SN74ABT16241A**  
**16-BIT BUFFERS/DRIVERS**  
**WITH 3-STATE OUTPUTS**

SCBS096F – FEBRUARY 1991 – REVISED JANUARY 1997

switching characteristics over recommended ranges of supply voltage and operating free-air temperature,  $C_L = 50$  pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	SN54ABT16241					UNIT
			V <sub>CC</sub> = 5 V, T <sub>A</sub> = 25°C			MIN	MAX	
			MIN	TYP	MAX			
t <sub>PLH</sub>	A	Y	0.9	2.7	3.4	0.9	3.8	ns
t <sub>PHL</sub>			0.9	2.7	3.9	0.9	4.6	
t <sub>PZH</sub>	OE or $\overline{OE}$	Y	1.2	3.3	4.2	1.2	5.1	ns
t <sub>PZL</sub>			1.3	3.4	5.9	1.3	7	
t <sub>PHZ</sub>	OE or $\overline{OE}$	Y	1.5	4.1	5.5	1.5	7	ns
t <sub>PLZ</sub>			1.7	3.6	5.1	1.7	5.7	

switching characteristics over recommended ranges of supply voltage and operating free-air temperature,  $C_L = 50$  pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	SN74ABT16241A					UNIT
			V <sub>CC</sub> = 5 V, T <sub>A</sub> = 25°C			MIN	MAX	
			MIN	TYP	MAX			
t <sub>PLH</sub>	A	Y	1	2.7	3.4	1	3.7	ns
t <sub>PHL</sub>			1	2.7	3.9	1	4.5	
t <sub>PZH</sub>	OE or $\overline{OE}$	Y	1.2	3.3	4.2	1.2	5	ns
t <sub>PZL</sub>			1.3	3.4	5.9	1.3	6.9	
t <sub>PHZ</sub>	OE or $\overline{OE}$	Y	1.5	4.1	5.2	1.5	6.2	ns
t <sub>PLZ</sub>			1.7	3.6	5.1	1.7	5.6	

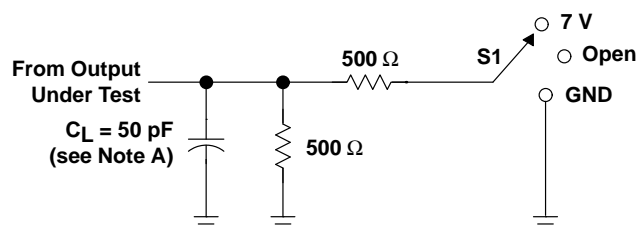
# SN54ABT16241, SN74ABT16241A

## 16-BIT BUFFERS/DRIVERS

### WITH 3-STATE OUTPUTS

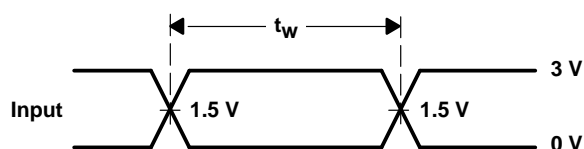
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#### PARAMETER MEASUREMENT INFORMATION

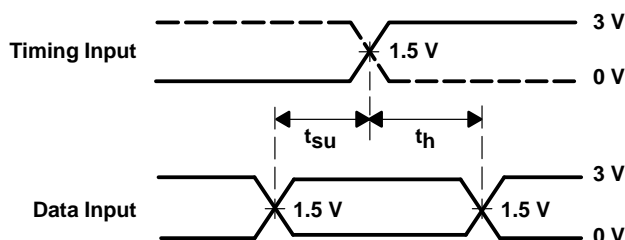


LOAD CIRCUIT

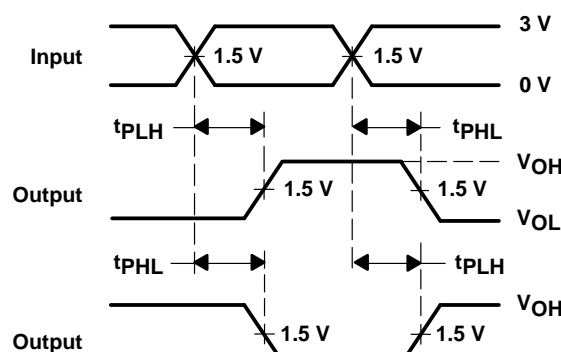
TEST	S1
$t_{PLH}/t_{PHL}$	Open
$t_{PLZ}/t_{PZL}$	7 V
$t_{PHZ}/t_{PZH}$	Open



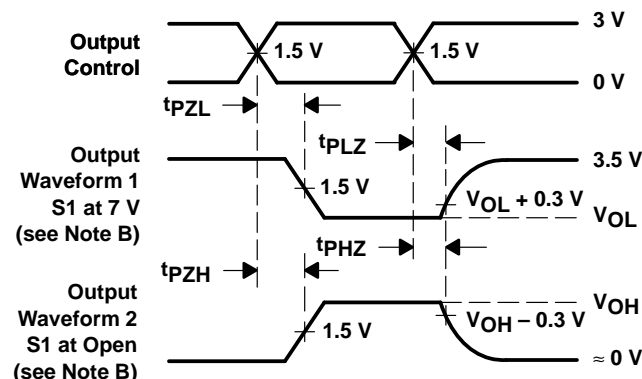
VOLTAGE WAVEFORMS  
PULSE DURATION



VOLTAGE WAVEFORMS  
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS  
PROPAGATION DELAY TIMES  
INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS  
ENABLE AND DISABLE TIMES  
LOW- AND HIGH-LEVEL ENABLING

- NOTES: A.  $C_L$  includes probe and jig capacitance.
- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10 \text{ MHz}$ ,  $Z_O = 50 \Omega$ ,  $t_r \leq 2.5 \text{ ns}$ ,  $t_f \leq 2.5 \text{ ns}$ .
- D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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